



High Performance Wafer Handling Tools Since 1975

MCP2-8

200mm Wafer Handling Edge-Grip Mechanical Pick

Ordering part number: MCP2-8

Wafer Size – 200mm x 725 μ

An edge-grip normally closed (consistent force) edge exclusion mechanical pick for handling 200mm round substrates from the wafer edge. Base material is ESD safe polypropylene for longevity, antistatic properties, and general chemical resistance. Wafer contact pad is perfluorinated o-ring strip for grip/hold on the wafer without scratching or leaving outgassing behind.

Handle length: 7.0" (177.8mm)

Gripper width: 2.12" (53.8mm)

Frontside contact: 5mm

Backside contact: 8mm

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